NEC NEC LCD Technologies, Ltd.

TFT COLOR LCD MODULE

NL2432HC22-40J

8.9cm (3.5 Type) QVGA

DATA SHEET P DOD-PP-0129 (3rd edition)

This DATA SHEET is updated document from DATA SHEET DOD-PP-0011(2).

All information is subject to change without notice. Please confirm the sales representative before starting to design your system.

INTRODUCTION

The Copyright to this document belongs to NEC LCD Technologies, Ltd. (hereinafter called "NEC"). No part of this document will be used, reproduced or copied without prior written consent of NEC.

NEC does and will not assume any liability for infringement of patents, copyrights or other intellectual property rights of any third party arising out of or in connection with application of the products described herein except for that directly attributable to mechanisms and workmanship thereof. No license, express or implied, is granted under any patent, copyright or other intellectual property right of NEC.

Some electronic parts/components would fail or malfunction at a certain rate. In spite of every effort to enhance reliability of products by NEC, the possibility of failures and malfunction might not be avoided entirely. To prevent the risks of damage to death, human bodily injury or other property arising out thereof or in connection therewith, each customer is required to take sufficient measures in its safety designs and plans including, but not limited to, redundant system, fire-containment and anti-failure.

The products are classified into three quality grades: "Standard", "Special", and "Specific" of the highest grade of a quality assurance program at the choice of a customer. Each quality grade is designed for applications described below. Any customer who intends to use a product for application other than that of Standard quality grade is required to contact an NEC sales representative in advance.

The **Standard** quality grade applies to the products developed, designed and manufactured in accordance with the NEC standard quality assurance program, which are designed for such application as any failure or malfunction of the products (sets) or parts/components incorporated therein a customer uses are, directly or indirectly, free of any damage to death, human bodily injury or other property, like general electronic devices.

Examples: Computers, office automation equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment, industrial robots, etc.

The **Special** quality grade applies to the products developed, designed and manufactured in accordance with an NEC quality assurance program stricter than the standard one, which are designed for such application as any failure or malfunction of the products (sets) or parts/components incorporated therein a customer uses might directly cause any damage to death, human bodily injury or other property, or such application under more severe condition than that defined in the Standard quality grade without such direct damage.

Examples: Control systems for transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, medical equipment not specifically designed for life support, safety equipment, etc.

The **Specific** quality grade applies to the products developed, designed and manufactured in accordance with the standards or quality assurance program designated by a customer who requires an extremely higher level of reliability and quality for such products.

Examples: Military systems, aircraft control equipment, aerospace equipment, nuclear reactor control systems, medical equipment/devices/systems for life support, etc.

The quality grade of this product is the "Standard" unless otherwise specified in this document.

CONTENTS

INTRODUCTION	2
1. OUTLINE	4
1.1 STRUCTURE AND PRINCIPLE	
1.2 APPLICATION	
1.3 FEATURES	4
2. GENERAL SPECIFICATIONS	5
3. BLOCK DIAGRAM	6
4. DETAILED SPECIFICATIONS	
4.1 MECHANICAL SPECIFICATIONS	
4.2 ABSOLUTE MAXIMUM RATINGS	
4.3 ELECTRICAL CHARACTERISTICS	
4.4 SETTING OF THE INTERNAL RESISTER	
4.5 INTERFACE PIN CONNECTIONS	
4.6 DISPLAY COLORS AND INPUT DATA SIGNALS	
4.7 DISPLAY POSITIONS	
4.8 SCANNING DIRECTIONS	
4.9 INPUT SIGNAL TIMINGS	
4.9.1 RGB interface (Ta= 25°C, VCC= 3.0V)	
4.9.2 Serial interface (Ta= 25°C, VCC= 3.0V)	
4.10 OPTICAL CHARACTERISTICS	
5. RELIABILITY TESTS	
6. PRECAUTIONS	
6.1 MEANING OF CAUTION SIGNS	
6.2 CAUTIONS	
6.3 ATTENTIONS	
6.3.1 Handling of the product	
6.3.2 Environment	
6.3.4 Other	
7. OUTLINE DRAWINGS	
/. UUILINE DRAMINGS	, 41

1. OUTLINE

1.1 STRUCTURE AND PRINCIPLE

Color LCD module NL2432HC22-40J is composed of the amorphous silicon thin film transistor liquid crystal display (a-Si TFT LCD) panel structure with driver LSIs for driving the TFT (Thin Film Transistor) array and a backlight.

The a-Si TFT LCD panel structure is injected liquid crystal material into a narrow gap between the TFT array glass substrate and a color-filter glass substrate.

Color (Red, Green, Blue) data signals from a host system (e.g. signal generator, etc.) are modulated into best form for active matrix system by a controller, and sent to the driver LSIs which drive the individual TFT arrays.

The TFT array as an electro-optical switch regulates the amount of transmitted light from the backlight assembly, when it is controlled by data signals. Color images are created by regulating the amount of transmitted light through the TFT array of red, green and blue dots.

1.2 APPLICATION

• PDAs

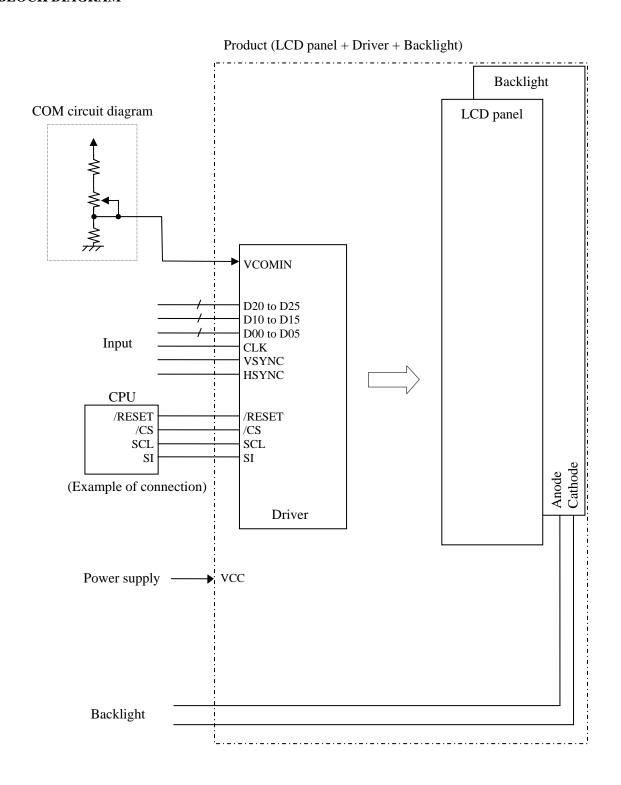
1.3 FEATURES

- Adoption of SR-NLT (Super-Reflective Natural Light TFT) (Transflective type)
- Backlight attached
- High luminance
- High contrast
- Including LCD controller and power supply
- 6-bit digital RGB signals

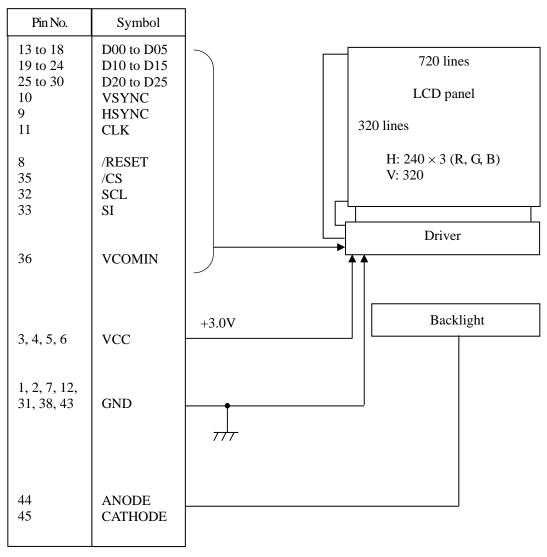
2. GENERAL SPECIFICATIONS

Display area	53.64 (H) × 71.52 (V) mm			
Diagonal size of display	8.9cm (3.5 inches)			
Drive system	a-Si TFT active matrix			
Display color	262,144 colors			
Pixel	240 (H) × 320 (V) pixels			
Pixel arrangement	RGB (Red dot, Green dot, Blue dot) vertical stripe			
Dot pitch	0.0745 (H) × 0.2235 (V) mm			
Pixel pitch	0.2235 (H) × 0.2235 (V) mm			
Module size	63.5 (H) × 85.0 (V) × 3.0 (D) mm (typ.)			
Weight	25 g (typ.)			
Polarizer surface	Clear			
Polarizer pencil-hardness	rdness 3H (min.) [by JIS K5400]			
Luminance	At IL = 20mA $220cd/m2 (typ.)$			
Reflectance ratio	15% (typ.)			
Contrast ratio	At transmissive mode, IL= 20mA 150:1 (typ.) At reflective mode 15:1 (typ.)			
Response time	Ton+Toff $(10\% \leftarrow \rightarrow 90\%)$ 30 ms (typ., at transmissive mode) 16 ms (typ., at reflective mode)			
Designed viewing direction	Viewing direction without image reversal: down side (6 o'clock)			
6-bit digital signals for data of RGB colors, Dot clock (CLK), Horizontal synchronous signal (HSYNC), Vertical synchronous signal (VSYNC) Serial interface signals (/CS, SCL, SI)				
Supply voltage	VCC: 3.0V (typ.)			
Power consumption	LCD panel: 50mW (typ.) Backlight: 384mW (typ., at IL=20mA)			

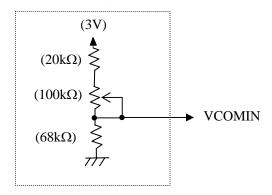
3. BLOCK DIAGRAM



FPC I/F



Reference design of COM circuit



 $\frac{1}{2}$

4. DETAILED SPECIFICATIONS

4.1 MECHANICAL SPECIFICATIONS

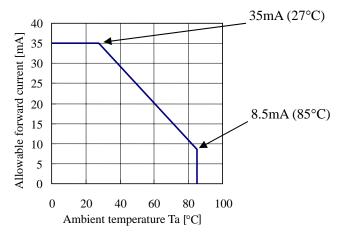
Parameter	Specification			
Module size	$63.5 \pm 0.3 \text{ (W)} \times 85.0 \pm 0.3 \text{ (H)} \times 3.0 \pm 0.2 \text{ (D)}$	Note1	mm	
Display area	53.64 (H) × 71.52 (V)	Note1	mm	
Weight	25 (typ.), 28 (max.)		g	

Note1: See "7. OUTLINE DRAWINGS".

4.2 ABSOLUTE MAXIMUM RATINGS

	Parameter	Symbol	Rating	Unit	Remarks
Supply volt	age	VCC	-0.5 to +3.5	V	Ta= 25°C
Logic input	voltage	VI	-0.5 to VCC+0.5	V	Logic signals
	Reverse voltage	VR	≤ 30	V	
	Power dissipation	PD	≤ 738	mW	Ta= 25°C
Backlight	Forward current	IL	Note1	mA	
	Pulse forward current		100	mA	Pulse width ≤ 10 ms, Duty $\leq 1/10$
Storage tem	Storage temperature		-20 to +70	°C	-
Operating to	emperature	Тор	-20 to +70	٠.ر	Product surface Note2
			≤ 95		Ta≤ 40°C
Relative hu	elative humidity Note3		≤ 85	%	40°C <ta≤ 50°c<="" td=""></ta≤>
			≤ 70		50°C <ta≤ 55°c<="" td=""></ta≤>
Absolute humidity Note3		AH	≤ 73 Note4	g/m ³	Ta> 55°C
Storage alti	tude		≤ 13,600	m	-20°C ≤ Ta ≤ 70°C
Operating a	ıltitude		≤ 4,850	m	$-20^{\circ}\text{C} \le \text{Ta} \le 70^{\circ}\text{C}$

Note1: Allowable forward current



Note2: Measured at display area

Note3: No condensation

Note4: Water amount at Ta= 55°C and RH= 70%

4.3 ELECTRICAL CHARACTERISTICS

(1) Logic/LCD driving

(Ta= 25°C)

Parameter	Symbol	min.	typ.	max.	Unit	Remarks
Logic supply voltage	VCC	2.85	3.0	3.15	V	-
Logic input high voltage	VIH	0.8VCC	-	VCC	V	Logic signal
Logic input low voltage	VIL	0	-	0.2VCC	V	Logic signal
COM high voltage	COM/H	-	1.8	-	V	at VCC= 3.0V Note1
VCC supply current	ICC	-	16.5	26	mA	at VCC= 3.0V Note2

Note1: The optimum value for COM/H is in the range of 1.3 V to 2.3 V.

Recommended adjustment display for COM/H



Note2: PPCLK= (5.0)MHz, PPHSYNC= (19.53)kHz, PPVSYNC= (60)Hz, Checkered flag pattern (by EIAJ ED-2522)

(2) Backlight

(Ta= 25°C)

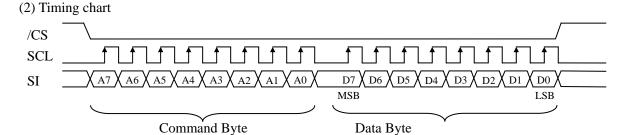
Parameter	Symbol	min.	typ.	max.	Unit	Remarks
Forward Current	IL	-	20	22	mA	-
Forward Voltage	VL	-	19.2	21.0	V	at IL= 20mA

4.4 SETTING OF THE INTERNAL RESISTER

Initial setting of the internal Resister is undefined data. So the Resister Data must be written in the Resister, after initialization by the /RESET pin. The Resister Data can be written from serial interface pins (/CS, SCL and SI). The setting method is as follows.

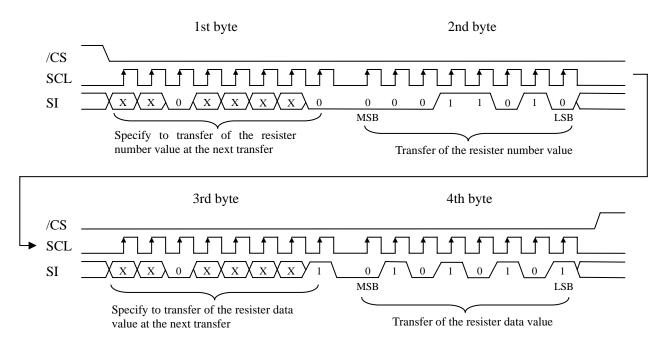
(1) Command 1	Byte F	unction
---------------	--------	---------

Bits	Functions	Discription
A7	-	-
A6	-	-
A5	Read / Write	0:Write 1:Read
A4	-	-
A3	-	-
A2	-	-
A1	-	-
A0	Register Number / Data	0:Register Number 1:Register Data



- Register Number or Register Data

Ex) When data 55h is written to Register R26 (R1Ah)



Note1: During 32-bit transfer of the Resister Data, /CS pin (Pin No.35) must be maintained active.

Note2: "X" is set in accordance with the usage conditions.

(3) Command sequence

①Power On

Sequence	Register Number	Data	Comment	Sequence	Register Number	Data	Comment
1	Power On			26	R76	01h	-
2	1ms min. w	ait.		27	R77	01h	-
3	Reset by the	e /RESET pi	n (Pin No. 8).	28	R80	00h	-
4	1ms min. w	ait after /RE	SET↑.	29	R81	00h	-
5	R3	01h	-	30	R82	2Eh	-
6	R1	00h	-	31	R83	C4h	-
7	R100	0Fh	1	32	R86	15h	1
8	R101	3Fh	-	33	R87	EDh	-
9	R102	3Fh	-	34	R95	3Fh	-
10	R103	00h	-	35	R96	22h	-
11	R104	00h	-	36	R25	76h	-
12	R105	30h	-	37	R26	54h	-
13	R106	04h	-	38	R27	67h	-
14	R107	37h	-	39	R28	60h	-
15	R108	17h	-	40	R29	04h	
16	R109	00h	-	41	R30	1Ch	-
17	R110	40h	-	42	R31	A9h	-
18	R111	30h	-	43	R32	00h	-
19	R112	04h	-	44	R33	20h	-
20	R113	37h	-	45	R24	77h	-
21	R114 17h -			46	30 μs min	. wait.	
22	R115 00h -			47	Data input	start	
23	R116	40h	-	48	R59	01h	-
24	R2	40h	-	49	20 ms min. wait.		
25	R75	04h	-	50	R0	00h	49

②Power Off

Sequence	Register Number	Data	Comment		
1	R0	08h	-		
2	25 ms min. wait.				
3	R24	00h	-		
4	20 ms min. wait.				
5	R1	08h	-		
6	Power Off				

3Standby

Sequence	Register Number	Data	Comment		
1	R0	08h	-		
2	25 ms min. wait.				
3	R24	00h	-		
4	20 ms min. wait.				
5	R1	08h	-		

Wake Up

Sequence	Register Number	Data	Comment
1	R1	00h	-
2	R24	FFh	-
3	30 μs min	. wait.	
4	R0	00h	-

Note1: Be sure to perform reset by the /RESET pin (Pin No. 8) every power-on

Note2: Write the Resister Data every power-on, because the data are not stored in the product.

4.5 INTERFACE PIN CONNECTIONS

CN1 (FPC)

Adaptable socket: FH23-45S-0.3SHW(05) (Hirose Electric Co., Ltd.(HRS))

Pin No.	Symbols	Function	ons	Pin No.	Symbols	Function	S
1	GND	Ground	Note1	25	D20	Red data (LSB)	
2	GND	Ground	Note1	26	D21	Red data	
3	VCC			27	D22	Red data	
4	VCC	Dovice supply	Note1	28	D23	Red data	
5	VCC	Power supply	Note1	29	D24	Red data	
6	VCC			30	D25	Red data (MSB)	
7	GND	Ground	Note1	31	GND	Ground	Note1
8	/RESET	Reset		32	SCL	Serial clock	
9	HSYNC	Horizontal synchron	nous signal	33	SI	Serial input	
10	VSYNC	Vertical synchronou	ıs signal	34	RSVD	Keep this pin Open.	
11	CLK	Dot clock		35	/CS	Chip selection	
12	GND	Ground	Note1	36	VCOMIN	COM high voltage in	put
13	D00	Blue data (LSB)		37	N.C.	Keep this pin Open.	
14	D01	Blue data		38	GND	Ground	Note1
15	D02	Blue data		39	N.C.		
16	D03	Blue data		40	N.C.	W 4h:: O	
17	D04	Blue data		41	N.C.	Keep this pin Open.	
18	D05	Blue data (MSB)		42	N.C.		
19	D10	Green data (LSB)		43	GND	Ground	Note1
20	D11	Green data		44	ANODE	LED voltage (Anode)	ı
21	D12	Green data		45	CATHODE	LED voltage (Cathod	e)
22	D13	Green data				•	
23	D14	Green data		1			
24	D15	Green data (MSB)		1			

Note1: All GND terminals should be used without any non-connected lines.

Note2: Do not fold the FPC. When folding the FPC, pattern disconnection may occur. In case of bending FPC, the minimum curvature (R) must be more than 1.0 mm.

Description of terminals

Terminals	Description
	When /RESET is L, an internal reset is performed.
/RESET	The reset operation is executed at the /RESET signal level.
	Be sure to perform reset by this pin every power-on.
/CS	This pin is used for chip selection signals. When /CS= L, the chip is active and can
/C3	perform data I/O operations including command and data I/O.
SCL	This pin is clock input of serial interface.
SI	This pin is data input of serial interface.
VCOMIN	This pin is the Common high voltage. The voltage needs to be adjusted.
VCOMIN	See "3 BLOCK DIAGRAM - Reference design of COM circuit".
ANODE,	Defen to the heless "Cinemits of heal-light"
CATHODE	Refer to the below "Circuits of backlight".

Note1: Circuits of backlight



Circuits of backlight

4.6 DISPLAY COLORS AND INPUT DATA SIGNALS

This product can display in equivalent to 262,144 colors in 64 gray scales. Also the relation between display colors and input data signals is as the following table.

Display	colors												High l						
_ ===		R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	В3	B2	B1	B0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
lors	Red	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
Basic colors	Magenta	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
asic	Green	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
B	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
o ₂		0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
scal	dark	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
ay s	↑			:						:	:						:		
Red gray scale	\downarrow			:						:	:						:		
Rec	bright	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0
		1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
ale		0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
23S	dark	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
Green gray scale	1			:						:	:						:		
g us	\downarrow			:						:	:						:		
irec	bright	0	0	0	0	0	0	1	1	1	1	0	1	0	0	0	0	0	0
O		0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
<u>e</u>		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
scal	dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
Blue gray scale	↑			:						:	:						:		
e gi	\downarrow			:						:							:		
Blu	bright	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	0	1
		0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

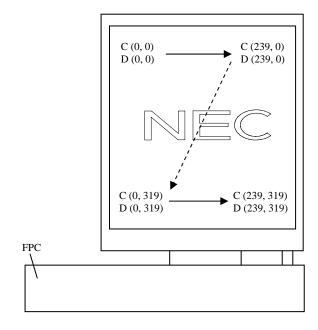
4.7 DISPLAY POSITIONS

The following table is the coordinates per pixel (See figure of "4.8 SCANNING DIRECTIONS".).

C (0, 0)	C (1,	0)				
R G	B R G	В				
	1					
$\begin{array}{ccc} C(&0,&0) \end{array}$	C(1, 0)	• • •	C(X, 0)	•••	C(238, 0)	C(239, 0)
C(0, 1)	C(1, 1)	•••	C(X, 1)	• • •	C(238, 1)	C(239, 1)
•	•	•	•	•	•	•
•	•	•	•	•	•	•
C(0, Y)	C(1, Y)	• • •	C(X,Y)	• • •	C(238, Y)	C(239, Y)
•	•	•	•	•	•	•
•	•	• • •	•	• • •	•	•
C(0, 318)	C(1, 318)	• • •	C(X, 318)	• • •	C(238, 318)	C(239, 318)
C(0, 319)	C(1, 319)	• • •	C(X, 319)	• • •	C(238, 319)	C(239, 319)

4.8 SCANNING DIRECTIONS

The following figures are seen from a front view. Also the arrow shows the direction of scan.



Note1: Meaning of C (X, Y) and D (X, Y)

C (X, Y): The coordinates of the display position (See "4.7 DISPLAY POSITIONS".)

D (X, Y): The data number of input signal for LCD panel

4.9 INPUT SIGNAL TIMINGS

4.9.1 RGB interface (Ta= 25°C, VCC= 3.0V)

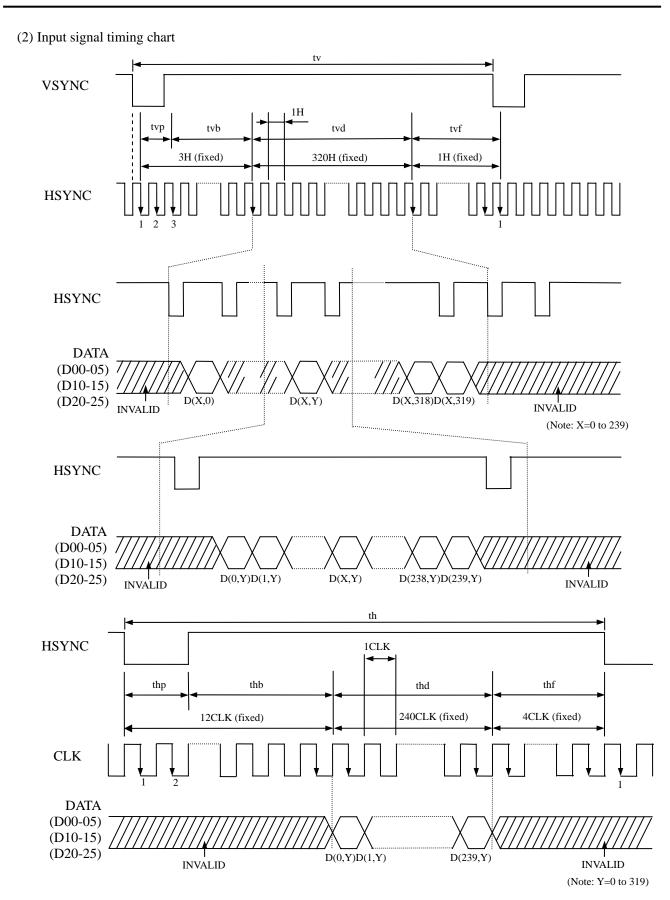
(1) Timing characteristics

	Parameter		Symbol	min.	typ.	max.	Unit	Remarks
	Frequency		1/tc	4.81	5.0	5.12	MHz	200ns (typ.)
CLK	Duty		tcd	0.4	0.5	0.6	-	
	Rise time, Fall	time	tcrf	-	-	15	ns	-
DATA	CLK-DATA	Setup time	tds	15	-	-	ns	
(D00-05) (D10-15)	CLK-DAIA	Hold time	tdh	15	-	-	ns	-
(D20-25)	Rise time, Fall	time	tdrf	-	-	15	ns	
	Cyala		th	50.0	51.2	53.2	μs	19.53kHz (typ.)
	Cycle		un		256		CLK	
	Display period		thd		240		CLK	
	Front-porch		thf	4			CLK	
HSYNC	Pulse width		thp	2	8	-	CLK	
	Back-porch	Back-porch			4		CLK	-
	CLK-	Setup time	ths	15	-	-	ns	
	HSYNC	Hold time	thh	15	-	-	ns	
	Rise time, Fall	time	thrf	-	-	15	ns	
	Cycle		tv	16.2	16.59	17.24	ms	60Hz (typ.)
	Cycle		l tv		324		Н	
	Display period		tvd		320		Н	
VSYNC	Front-porch Pulse width		tvf		1		Н	
VOINC			tvp	1	2	-	Н	-
	Back-porch		tvb		1		Н	
	VSYNC-HSYNC timing		tvh	15	-	-	ns	
	Rise time, Fall	time	tvrf	-	-	15	ns	

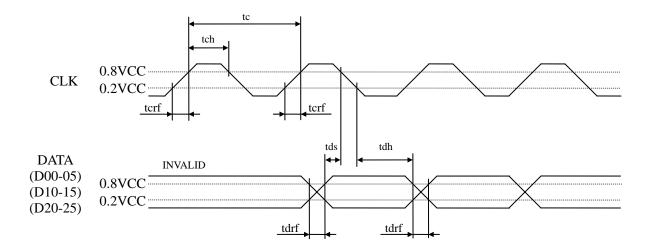
Note1: Definition of parameters is as follows.

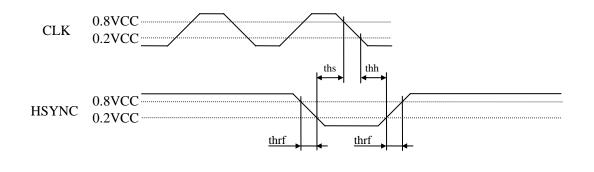
tc= 1CLK, tcd= tch/tc, th= 1H

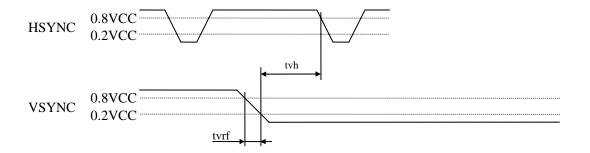
Note2: All parameters should be kept within the specified range.



Note1: Unless otherwise specified, the input level is defined to be VIH= 0.8VCC, VIL= 0.2VCC.







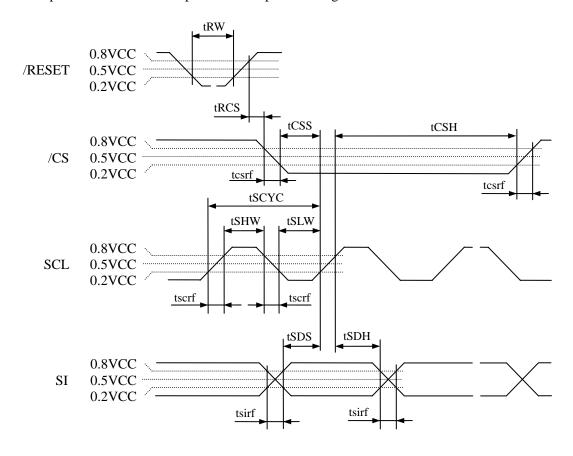
Note1: Unless otherwise specified, the input level is defined to be VIH= 0.8VCC, VIL= 0.2VCC.

4.9.2 Serial interface (Ta= 25°C, VCC= 3.0V)

(1) Timing characteristics

Parameter	Symbol	Condition	min.	typ.	max.	Unit	Remarks
Serial clock cycle	tSCYC	READ	450	-	-	ns	-
Serial clock cycle	ISCIC	WRITE	100	-	-	ns	-
SCL high level pulse width	tSHW	READ	210	-	-	ns	-
SCL night level pulse width	ISHW	WRITE	40	-	-	ns	-
SCL low level pulse width	tSLW	READ	210	-	-	ns	-
SCL low level pulse width	ISLW	WRITE	40	-	-	ns	-
/CS rise time, fall time	tcsrf	/CS	-	-	15	ns	-
SCL rise time, fall time	tscrf	SCL	-	-	15	ns	-
SI rise time, fall time	tsirf	SI	-	-	15	ns	-
/CS setup time	tCSS	/CS	50	-	-	ns	-
/CS hold time	tCSH	/CS	30	-	-	ns	-
Data setup time	tSDS	SI	30	-	-	ns	-
Data hold time	tSDH	SI	15	-	-	ns	-
Reset pulse width	tRW	/RESET	2	-	-	μs	-
/RESET↑ to /CS time	tRCS	/RESET↑ to /CS	1	-	-	ms	-

Note1: All parameters should be kept within the specified range.



Note2: Unless otherwise specified, the input level is defined to be VIH= 0.8VCC, VIL= 0.2VCC.

4.10 OPTICAL CHARACTERISTICS

<Backlight turning OFF>

(Note1, Note3, Note4)

Parameter	Condition	Symbol	min.	typ.	max.	Unit	Remarks
Reflectance ratio	White, at center	RE	10	15	-	%	Note6
Contrast ratio	White/Black, at center	CR	10	15	-	-	Note7

Reference data

(Note1, Note3, Note4)

Parameter	Condit	Condition			typ.	max.	Unit	Remarks
Chromaticity	Whit	Wx	1	0.32	1	1		
coordinates	winte		Wy	1	0.34	1	1	Note8
Color gamut	at center, against NT	SC color space	С	-	5	-	%	
White to black		90%→ 10%	Ton	-	7	14	me	Note9
Response time	Black to white	10%→ 90%	Toff	•	9	18	ms	Note10

<Backlight turning ON>

(Note2, Note3, Note5)

					(-,	, 110000
Parameter	Condition	Symbol	min.	typ.	max.	Unit	Remarks
Luminance	White at center $\theta R = 0^{\circ}$, $\theta L = 0^{\circ}$, $\theta U = 0^{\circ}$, $\theta D = 0^{\circ}$	L	150	220	-	cd/m ²	-
Contrast ratio	White/Black at center $\theta R = 0^{\circ}$, $\theta L = 0^{\circ}$, $\theta U = 0^{\circ}$, $\theta D = 0^{\circ}$	CR	75	150	-	-	Note7
Luminance uniformity	White $\theta R = 0^{\circ}$, $\theta L = 0^{\circ}$, $\theta U = 0^{\circ}$, $\theta D = 0^{\circ}$ Maximum luminance: 100%	LU	60	70	-	%	Note11

Reference data

(Note2, Note3, Note5)

Paran	neter	Condit	Condition		min.	typ.	max.	Unit	Remarks
Chromaticity		White		Wx	0.25	0.30	0.35	1	
coordinates	3	Wind	C	Wy	0.27	0.32	0.37	-	Note8
Color gamut $\theta R = 0^{\circ}, \theta L = 0^{\circ}, \theta U = 0^{\circ}$ at center, against NTSC		· ·	С	-	40	-	%		
Response time		White to black 90%→ 10%		Ton	-	7	14	me	Note9
Response t	iiie	Black to white $10\% \rightarrow 90\%$		Toff	-	23	46	ms	Note10
	Right	θU= 0°, θD=	0°, CR≥ 5	θR	-	35	-	0	
Viewing Left		θU= 0°, θD= 0°, CR≥ 5		θL	-	35	-	0	
angle	Up	θR= 0°, θL=	0°, CR≥ 5	θU	-	35	-	0	-
	Down	θR= 0°, θL=	0°, CR≥ 5	θD	-	35	-	0	

Note1: Measurement conditions are as follows.

Ta= 25 °C, VCC= 3.0V

Note2: Measurement conditions are as follows.

Ta= 25 °C, VCC= 3.0V, IL= 20mA

Left

Note3: Definition of viewing angles

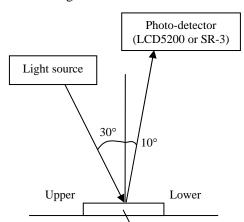
12 o'clock θU Right
Upper θD

Normal axis (Perpendicular)

Note4: In reflective mode (Backlight turning OFF), Reflectance ratio, Contrast ratio, Chromaticity coordinates and Color gamut are measured as follows.

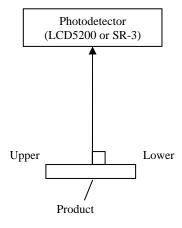
Lower

`FPC



Product or Standard diffused reflector

Note5: In transmissive mode (Backlight turning ON), Luminance, Contrast ratio, Chromaticity coordinates and Color gamut are measured as follows.



Note6: Definitions of reflectance ratio

The reflectance ratio is calculated by using the following formula.

Reflectance (RE) =
$$\frac{\text{Luminance of reflected light at white screen}}{\text{Luminance of standard diffused reflector}} \times 100$$

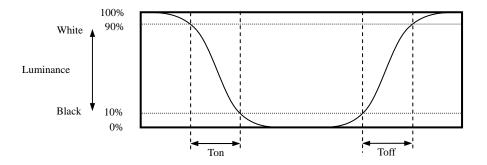
Note7: Definition of contrast ratio

The contrast ratio is calculated by using the following formula.

Note8: The White chromaticity coordinates are deviated by the LED deviation in addition to color filter deviation.

Note9: Definition of response times

Response time is measured, the luminance changes from "white" to "black", or "black" to "white" on the same screen point, by photo-detector. Ton is the time it takes the luminance change from 90% down to 10%. Also Toff is the time it takes the luminance change from 10% up to 90% (See the following diagram.).

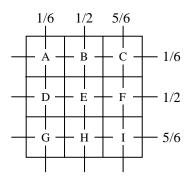


Note10: Product surface temperature: Top= 25°C

Note11: Definition of luminance uniformity

Luminance uniformity is calculated by using the following formula.

Luminance uniformity (LU) =
$$\frac{\text{Minimum luminance from A to I}}{\text{Maximum luminance from A to I}} \times 100$$



5. RELIABILITY TESTS

Test item	Condition	Judgement Note1		
High temperature and humidity (Operation)	 55 ± 2°C, RH = 85%, 240 hours Display data is black. 			
Heat cycle (Operation)	① -20 ± 3°C1 hour 70 ± 3°C1 hour ② 50 cycles, 4 hours/cycle ③ Display data is black.			
Thermal shock (Non operation)	 ① -20 ± 3°C30 minutes 70 ± 3°C30 minutes ② 100 cycles, 1 hour/cycle ③ Temperature transition time is within 5 minutes. 			
Low pressure (Non operation)	$\frac{1}{2} = \frac{1}{2} = \frac{1}$			
Low pressure (Operation)	① 53.3 kPa ② -20 ± 3°C24 hours ③ 70 ± 3°C24 hours			
ESD (Operation)	 150pF, 150Ω, ±10kV 3 places on a panel surface 10 times each places at 1 sec interval 			
Dust (Operation)	 Sample dust: No. 15 (by JIS-Z8901) 15 seconds stir 8 times repeat at 1 hour interval 			
Vibration (Operation)	 ① 30 to 100Hz, 19.6m/s² ② 30 minutes/cycle ③ X, Y, Z direction ④ 1 times each directions 	No display malfunctions		
Mechanical shock (Non operation)	 3,920m/s², 2.5ms ±X, ±Y, ±Z direction 1 times each directions 	No physical damages		

Note1:Display and appearance are checked under environmental conditions equivalent to the inspection conditions of defect specifications.

6. PRECAUTIONS

6.1 MEANING OF CAUTION SIGNS

The following caution signs have very important meaning. Be sure to read "6.2 CAUTIONS" and "6.3 ATTENTIONS", after understanding these contents!



This sign has the meaning that customer will be injured by himself or the product will sustain a damage, if customer has wrong operations.



This sign has the meaning that customer will get an electrical shock, if customer has wrong operations.



This sign has the meaning that customer will be injured by himself, if customer has wrong operations.

6.2 CAUTIONS



* Do not touch the working backlight. There is a danger of an electric shock.



- * Do not touch the working backlight. There is a danger of burn injury.
- * Do not shock and press the LCD panel and the backlight! There is a danger of breaking, because they are made of glass. (Shock: To be not greater 3,920m/s² and to be not greater 2.5ms)

6.3 ATTENTIONS **Z**



6.3.1 Handling of the product

- ① Take hold of both ends without touching the FPC when the product (LCD module) is picked up from the tray.
- ② Do not hook nor pull the FPC in order to avoid any damage.
- 3 When the product is put on the table temporarily, display surface must be placed downward.
- 4 When handling the product, take the measures of electrostatic discharge with such as earth band, ionic shower and so on, because the product may be damaged by electrostatic.
- (5) The product must be installed and/or handled without undue stress such as bends or twist. Bends, twist or undue stress to any portion may cause display failures. And also do not put heavy or hard materials on the product.
- ⑤ Do not hit or rub the surface of panel with hard materials, because it is easily scratched. (Polarizer pencil-hardness: 3H)
- ① When cleaning the panel surface, wipe it with a soft dry cloth.
- On not push nor pull the FPC while the product is working.
- Do not fold the FPC. When the FPC is folded, pattern disconnection may be caused. In case of bending FPC, the minimum curvature (R) must be more than 1.0 mm.
- When installing the product, do not contact a conductor such as a metal to the FPC excluding the terminal area. There is a risk of short circuit which is caused by breakage of insulation layer of the FPC.
- 1 When installing the product, apply the waterproof design to avoid going of water into the product.

*

6.3.2 Environment

- ① Do not operate or store in high temperature, high humidity, dewdrop atmosphere or corrosive gases. Keep the product in packing box with antistatic pouch in room temperature to avoid dusts and sunlight, when storing the product.
- ② In order to prevent dew condensation occurring by temperature difference, the product packing box should be opened after enough time being left under the environment of an unpacking room. Evaluate the leaving time sufficiently because a situation of dew condensation occurring is changed by the environmental temperature and humidity. (Recommended leaving time: 6 hours or more with packing state)
- 3 Do not operate in high magnetic field. Circuits may be broken down by it.
- 4 This product is not designed as radiation hardened.

6.3.3 Characteristics

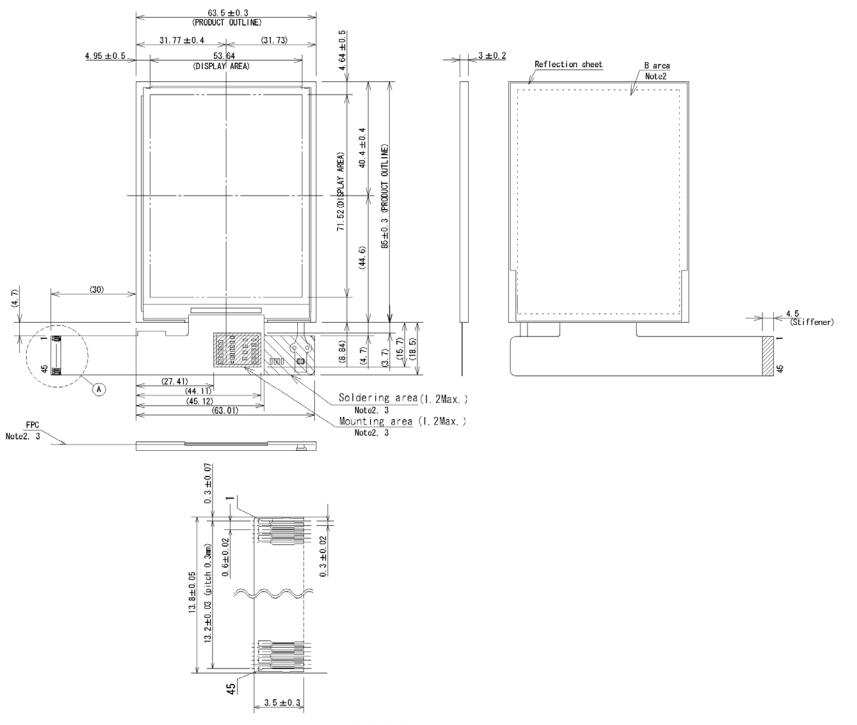
The following items are neither defects nor failures.

- ① Response time, luminance and color may be changed by ambient temperature.
- ② Display mura, flicker, vertical seam or small spot may be observed depending on display patterns.
- 3 Do not display the fixed pattern for a long time because it may cause image sticking.
- ④ Optical characteristics may be changed depending on input signal timings.

6.3.4 Other

- ① All GND terminals should be used without any non-connected lines.
- ② Do not disassemble the product.
- ② Pack the product with original shipping package, in order to avoid any damages during transportation, when returning the product to NEC.

7. OUTLINE DRAWINGS



Pin No.	Symbols	Pin No.	Symbols
1	GND	25	D20
2	GND	26	D21
3	VCC	27	D22
4	VCC	28	D23
5	VCC	29	D24
6	VCC	30	D25
7	GND	31	GND
8	/RESET	32	SCL
9	HSYNC	33	SI
10	VSYNC	34	RSVD
11	CLK	35	/CS
12	GND	36	VCOMIN
13	D00	37	N.C.
14	D01	38	GND
15	D02	39	N.C.
16	D03	40	N.C.
17	D04	41	N.C.
18	D05	42	N.C.
19	D10	43	GND
20	D11	44	ANODE
21	D12	45	CATHODE
22	D13		
23	D14		
24	D15		

Adaptable connecter: FH23-45S-0.3SHW(05) (HRS)

Detail A

Note1: The values in parentheses are for reference.

Note2: When installing the product to the customer equipment, do not apply undue stress to the B area, FPC, Soldering Area and Mounting Area. If not, it may cause display un-uniformity or break down of the product.

Note3: While the product is working, do not contact a conductor such as a metal to the Soldering Area and Mounting Area of the FPC.

Unit: mm

DATA SHEET DOD-PP-0129 (3rd edition)